

## Special Issue

# Thin Liquid Films: From Theory to Applications

### Message from the Guest Editor

The focus of this Special Issue of *Fluids* is on the recent advances in the realm of liquid films in the broad context of their theory and applications. This rapidly developing area of fluid dynamics and soft matter physics includes, but is not limited to such phenomena as stability of interfacial flows, Marangoni flow, Faraday waves and vibration, spinodal decomposition and Van der Waals forces, dewetting processes, deposition of coating layers and biofilms.

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### Guest Editor

Dr. Andrey Pototsky

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### Deadline for manuscript submissions

closed (30 April 2022)



## Fluids

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### Message from the Editor-in-Chief

*Fluids* (ISSN 2311-5521) is an international journal on all aspects of fluids in open access format: research articles, reviews and other contents are released on the internet immediately after acceptance. You are invited to contribute a research article or a comprehensive review for consideration and publication in *Fluids*. The scientific community and the general public have unlimited free access to the content as soon as it is published. Please consider *Fluids* as an exceptional, exciting enterprise ready to reward your trust, attention, and active participation.

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### Editor-in-Chief

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